Содержание

NMS-CS-IMX8MINI v2 ds-en

System on Module NMS-CS-IMX8MINI-V2 is based on an ARM archtecture proccessor NXP i.MX8M Mini.

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Technical Specifications

Таблица 1: Main technical specifications

Form factor	three 90-pins mezzanine connectors Hirose DF40C
CPU	Series: i.MX8M Mini (MIMX8MM6CVTKZAA)
	Number of Cores/Core Processor: 4 x ARM Cortex A53, 1 x ARM Cortex-M4F
	32 KB, 32 KB (instruction,data) L1 Cache
	512 KB unified L2 Cache
	Operating Frequency [Max] 1.6 GHz
RAM	LPDDR4 16 GB, interface 32-bit (K4F6E3S4HM-MGCJ000)
FLASH	eMMC FLASH 16 GB (THGAMRG7T13BAIL)
EEPROM	I2C serial EEPROM 2 KB, Unique ID 48 bit (24AA025)
Power management IC	PMIC (BD71847AMWV)
Other components	WIFI (WF200C)
	Ethernet PHY (KSZ9031)
	MIPI® DSI→LVDS bridge (SN65DSI83ZQER)
	3-lane high-speed MIPI compatible switch (NX3DV642GU,115)
Interfaces	1x PCIe
	2x USB OTG 2.0
	1x JTAG
	1x Gigabit Ethernet (from gigabit PHY)
	1x QSPI
	2x ECSPI
	4x SAI
	1x SPDIF
	1x SD
	4x UART
	4x I2C
	1x LVDS (MIPI DSI → LVDS)
	1x MIPI CSI
	14x GPIO
Power supply voltage	3.5-5V 🔧 **Fix Me!**
Power consumption	TBD
Dimensions	55.2 x 30.1 mm

Block Diagram
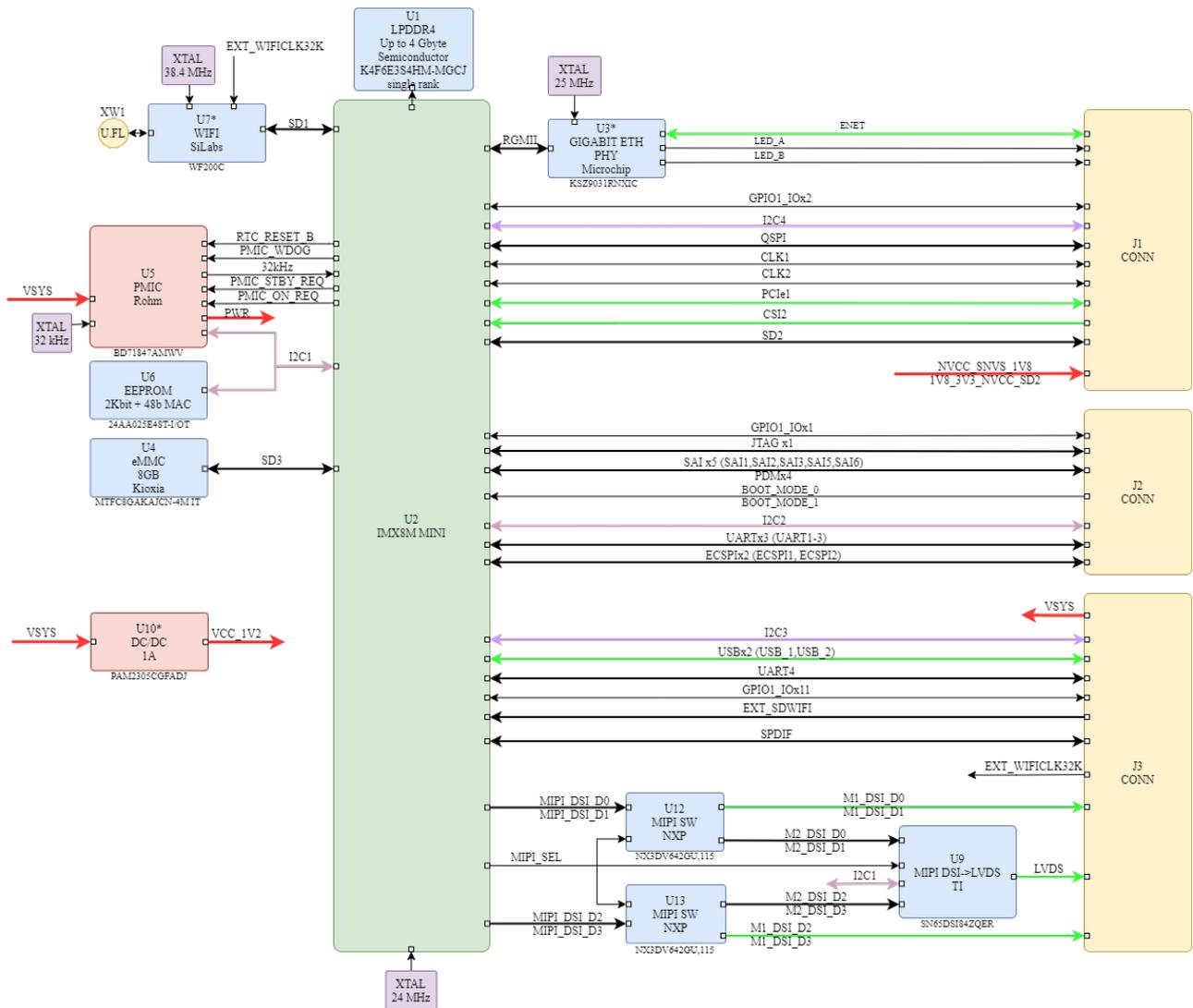

Рисунок 1: Module block diagram

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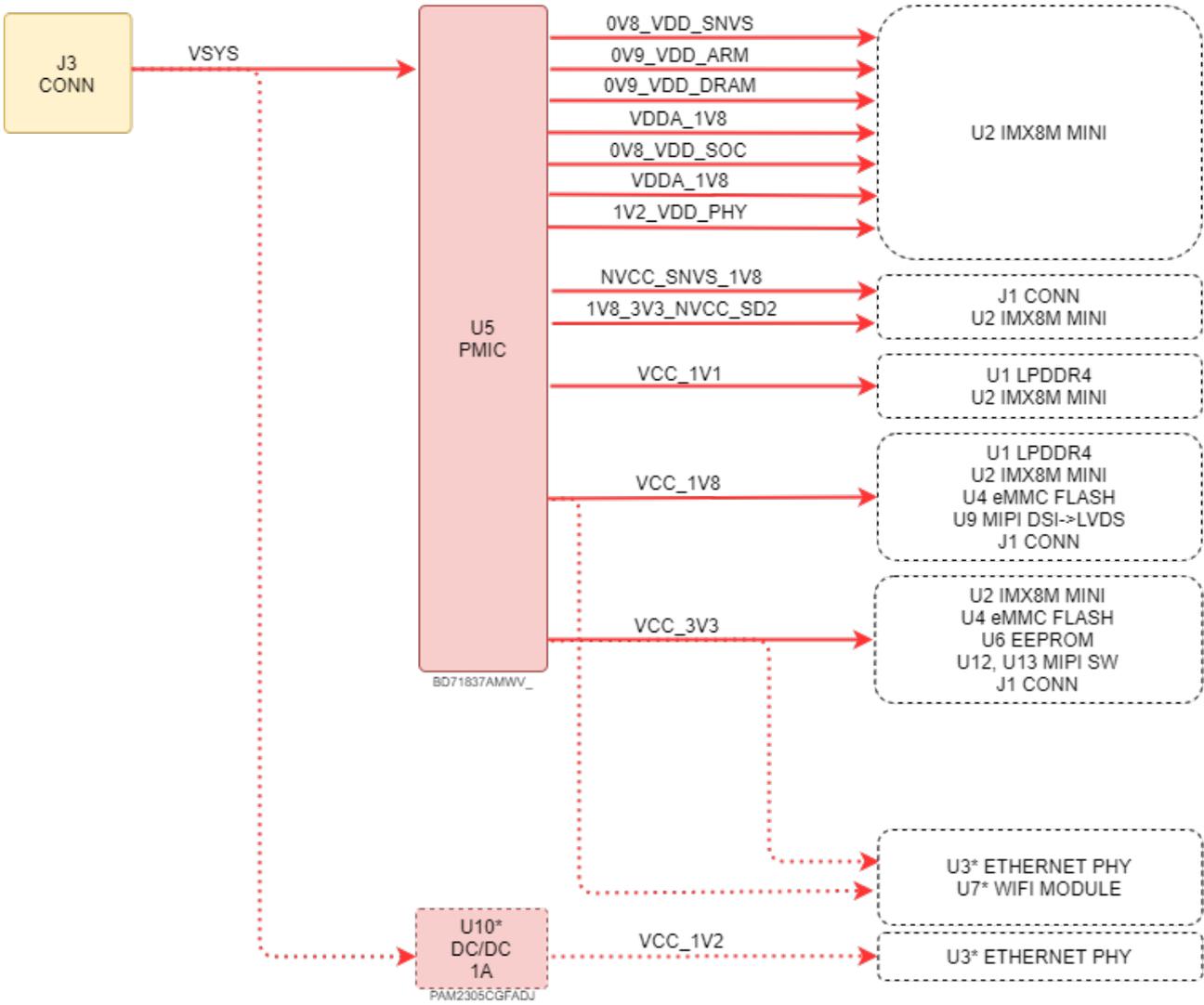INDIGO MICROSYSTEMS LTD

Power tree

Рисунок 2: Module power tree

Mechanical Specifications

Board dimensions are: 55.2 x 30.1 mm.
Printed circuit of the board is made of 10 layers, some of them are ground planes, for disturbance rejection.
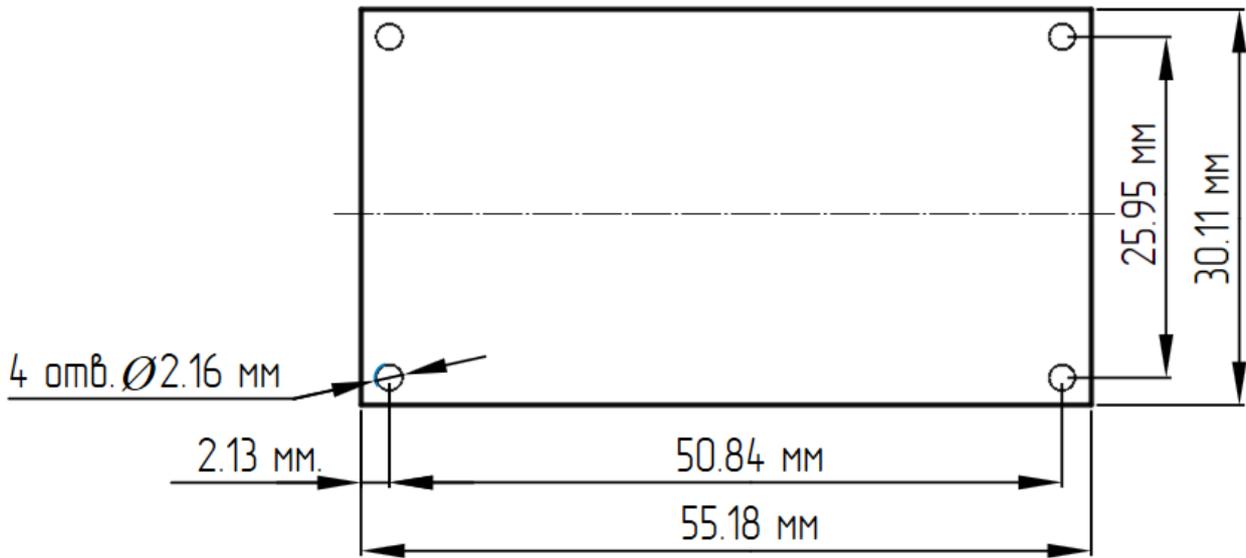

Рисунок 3: Module mechanical dimensions
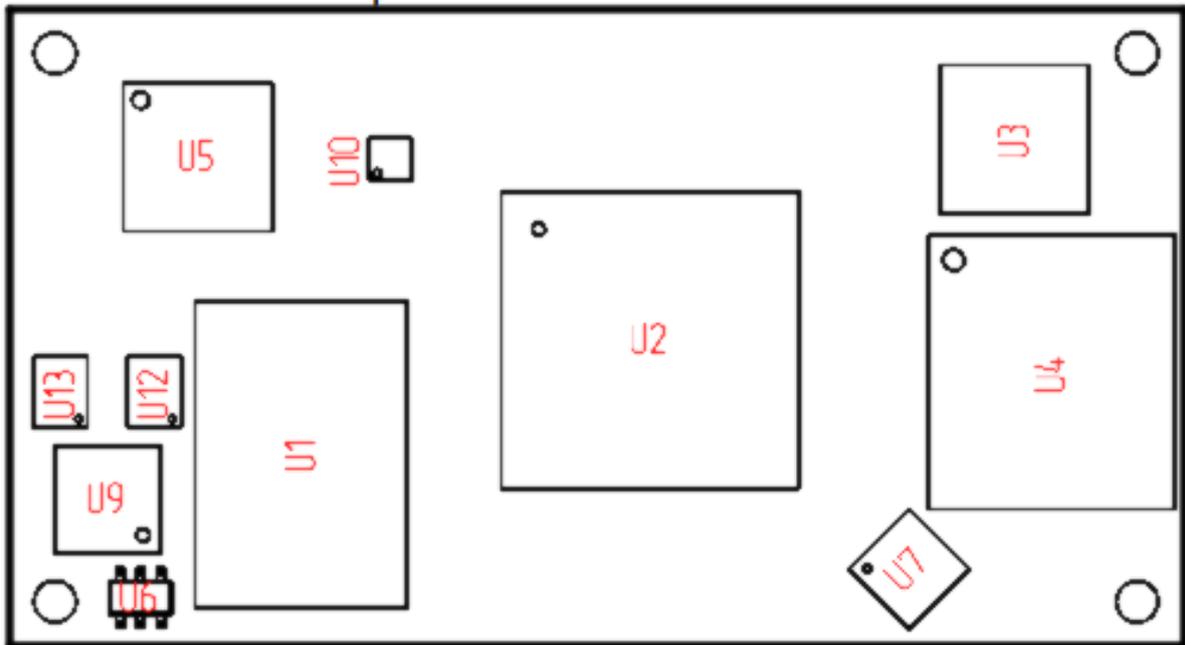
Main Hardware Components

Component Location

Top View

Рисунок 4: Component Location. Top View

Таблица 2: Component description on the board (Top side)

Designator	P/N	Description
U1	K4F6E3S4HM-MGCJ000	Memory LPDDR4
U2	MIMX8MM6CVTKZAA	Processor i.MX8M Mini
U3*	KSZ9031RN	Ethernet PHY
U4	THGAMRG7T13BAIL	e-MMC flash
U5	BD71847AMWV_	PMIC
U6	24AA025E48T-I/OT	EEPROM
U7*	WF200C	Network Co-Processor Wi-Fi
U9	SN65DSI83ZQER	MIPIDSI→LVDS bridge
U10*	PAM2305CGFADJ	DCDC converter 5V→1.2V
U12, U13	NX3DV642GU,115	3-lane high-speed MIPI compatible switch
* - absent in this version	🔧 Fix Me!	

Bottom View

On the bottom side of the board, the components are absent.

Processor

Figure 5 shows the functional modules in the i.MX8M MINI processor system.
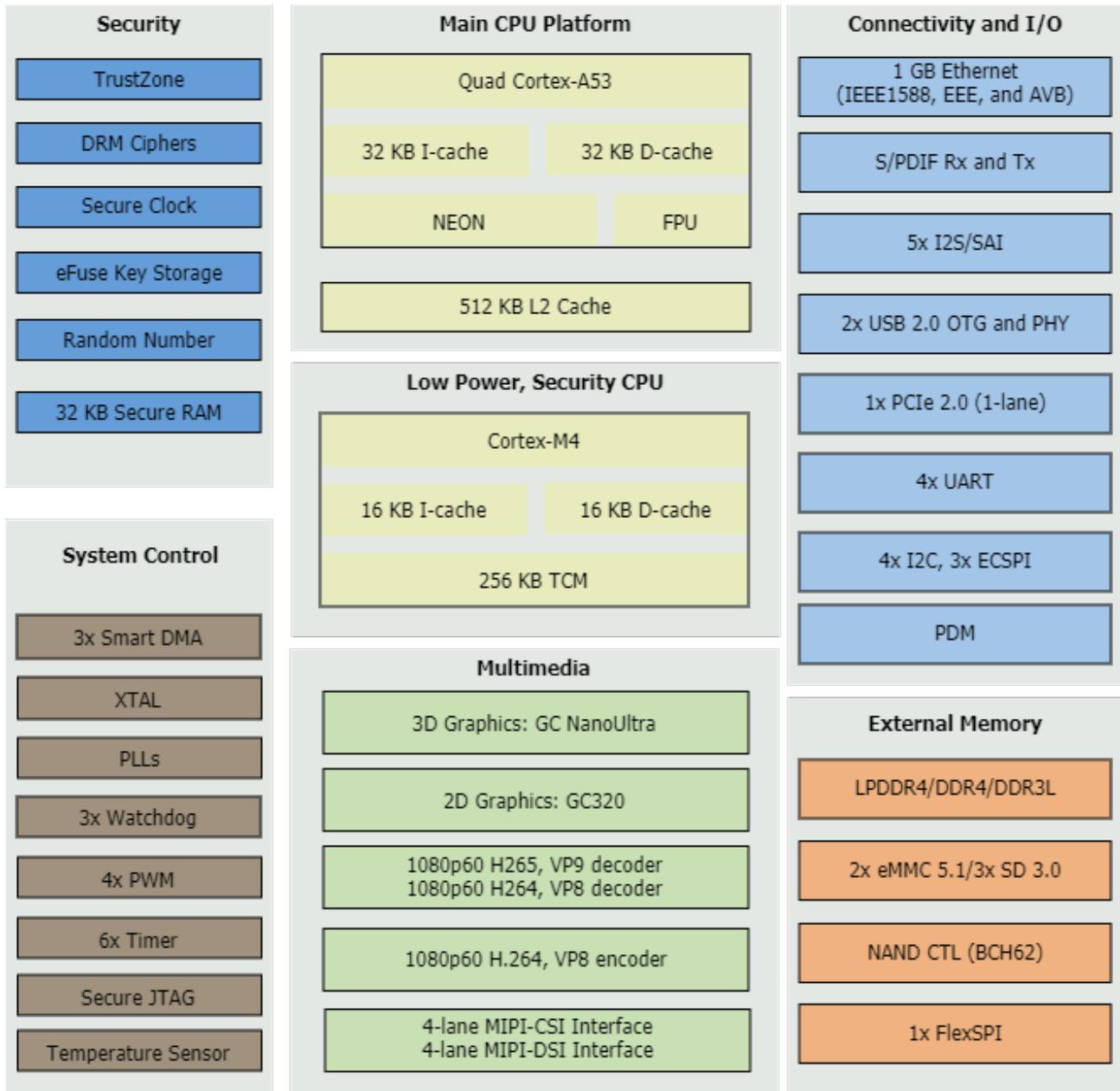
Security
- TrustZone
- DRM Ciphers
- Secure Clock
- eFuse Key Storage
- Random Number
- 32 KB Secure RAM

System Control
- 3x Smart DMA
- XTAL
- PLLs
- 3x Watchdog
- 4x PWM
- 6x Timer
- Secure JTAG
- Temperature Sensor

Main CPU Platform
- Quad Cortex-A53
  - 32 KB I-cache
  - 32 KB D-cache
  - NEON
  - FPU
- 512 KB L2 Cache

Low Power, Security CPU
- Cortex-M4
  - 16 KB I-cache
  - 16 KB D-cache
- 256 KB TCM

Multimedia
- 3D Graphics: GC NanoUltra
- 2D Graphics: GC320
- 1080p60 H265, VP9 decoder / 1080p60 H264, VP8 decoder
- 1080p60 H.264, VP8 encoder
- 4-lane MIPI-CSI Interface / 4-lane MIPI-DSI Interface

Connectivity and I/O
- 1 GB Ethernet (IEEE1588, EEE, and AVB)
- S/PDIF Rx and Tx
- 5x I2S/SAI
- 2x USB 2.0 OTG and PHY
- 1x PCIe 2.0 (1-lane)
- 4x UART
- 4x I2C, 3x ECSPI
- PDM

External Memory
- LPDDR4/DDR4/DDR3L
- 2x eMMC 5.1/3x SD 3.0
- NAND CTL (BCH62)
- 1x FlexSPI

Рисунок 5: i.MX8M Mini function modules

Interfaces

I2C

Three I2C interfaces are availbale on NMS-CS-IMX8MINI-V2.
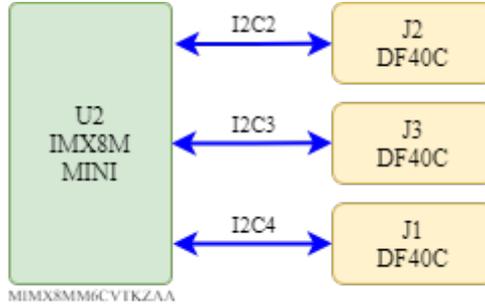
Рисунок 6: I2C interfaces

Таблица 3: I2C Address Mapping

Device	Address
MIPIDSI→2LVDS bridge	0x0101100
EEPROM	0x1010000
PMIC	0x1001000

Таблица 4: I2C signal pinouts on J1-J3 connectors

Signal Name	Pin(s)	Direction	Standard volgate (V)	Description	Connection
I2C2_SCL	J2.32	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus clock line.	U2.D10
I2C2_SDA	J2.30	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus data line.	U2.D9
I2C3_SCL	J3.46	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus clock line.	U2.E10
I2C3_SDA	J3.42	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus data line.	U2.F10
I2C4_SCL	J1.17	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus clock line.	U2.D13
I2C4_SDA	J1.19	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus data line.	U2.E13

where PU - pull-up resistor, PD - pull-down resistor.

Debugging/development interfaces

I2C

There is one I2C interface for communicating between processor and peripherals on NMS-CS-IMX8MINI-V2.
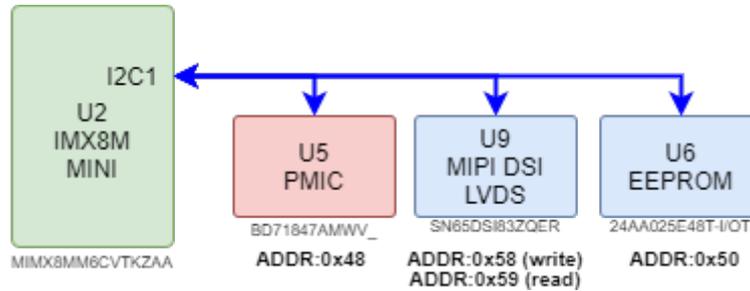

Рисунок 7: I2C1 interface

Таблица 5: IMX8M_MINI I2C singnals

Signal name	Pin(s)	Direction	Voltage standard	Description
I2C1_SCL	E9	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus clock line.
I2C1_SDA	F9	in/out	3.3 PU 4.7 kΩ	General purpose I2C Bus data line.

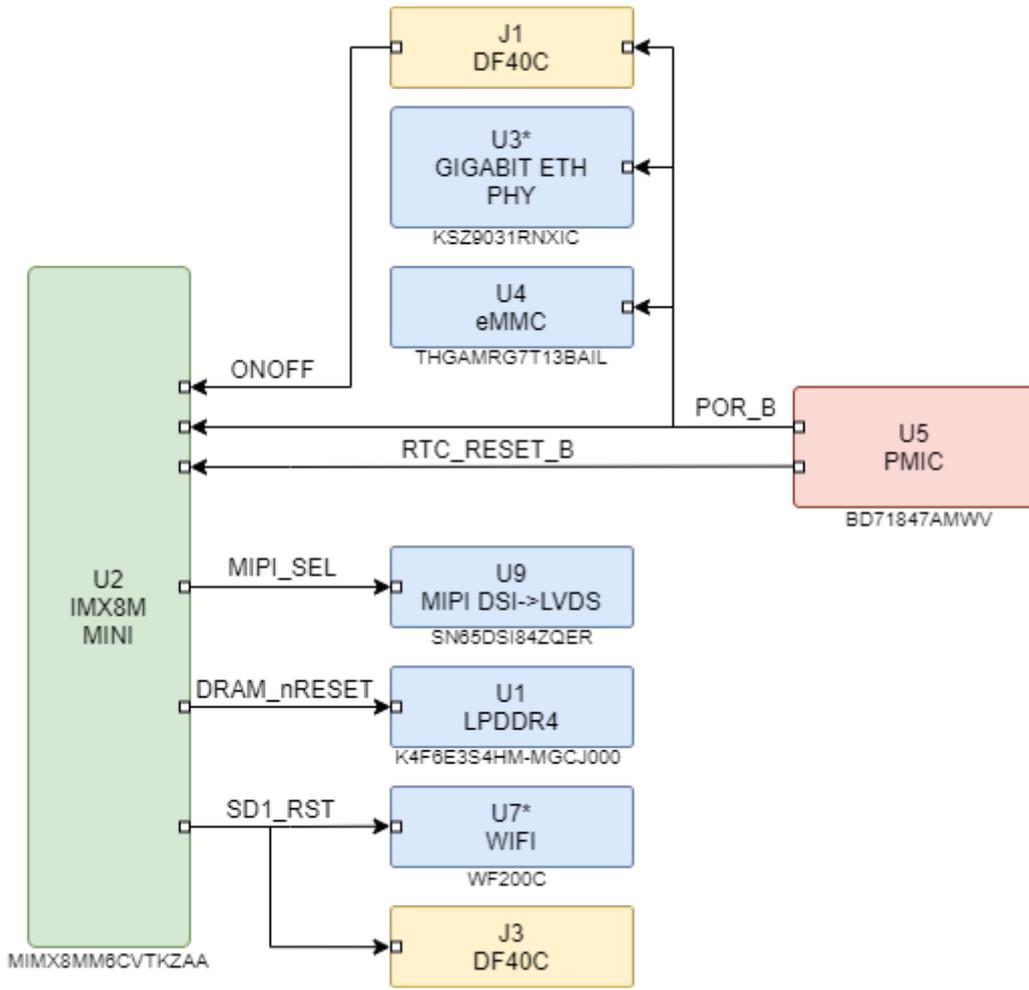where PU - pull-up resistor, PD - pull-down resistor.

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RESET

Рисунок 8: Reset signals

Таблица 6: PMIC reset signals

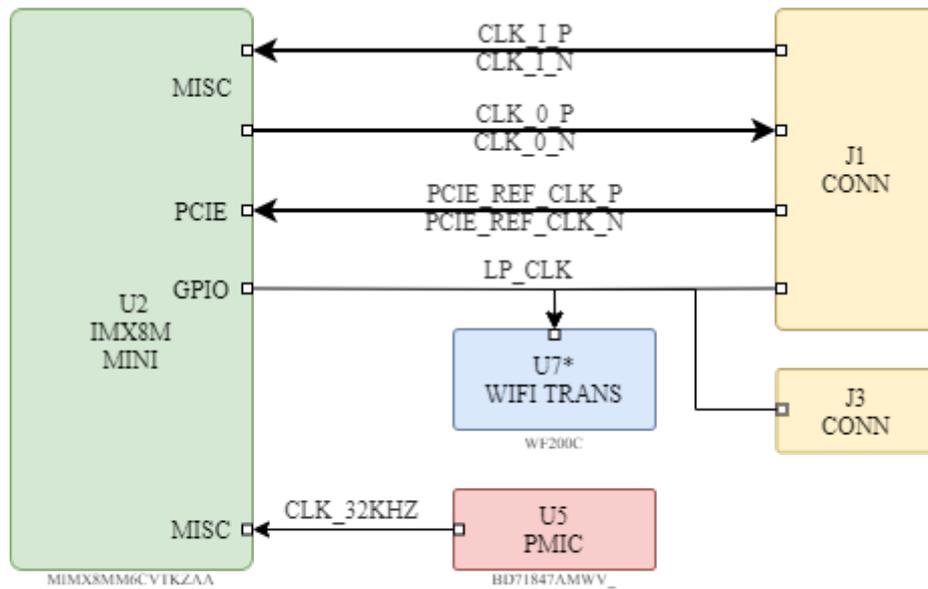| Signal name	Pin(s)	Voltage standard(V)	Circuit name	Connection	Description
PWRON	U5.40	1.8 PU 100 kΩ	PWRON_B	-	Not used
POR	U5.25	1.8 PU 10 kΩ	POR_B	U2.B24, J1.24	
			1V8_POR_B	U3.42, U4.K5	
RTC_RESET	U5.3	1.8 PU 100 kΩ	RTC_RESET	U2.F4	

where PU - pull-up resistor, PD - pull-down resistor.

CLK

Рисунок 9: Clock signals

Таблица 7: J1 socket clock signals

Signal name	Pin(s)	Voltage Standart(V)	Circuit Name	Connection
GPIO1_IO00	1		LP_CLK	U7.23 (through 0Ω)
NAND_DATA07/QSPIB_DATA3	35		CLK_I_N	U2.J27
NAND_DATA06/QSPIB_DATA2	37		CLK_I_P	U2.H27
NAND_CLE/QSPIB_SCLK	45		CLK_O_P	U2.H26
NAND_CE2_B/QSPIB_SS0_B	47		CLK_O_N	U2.J26
PCIE1_REF_CLKN	51		PCIE_REF_CLK_P	U2.B21
PCIE1_REF_CLKP	53		PCIE_REF_CLK_N	U2.A21

Таблица 8: J3 socket clock signals

Signal Name	Pin(s)	Voltage Standart(V)	Circuit name	Connection
CSI_P2_DN0	84		EXT_LP_CLK	U7.23 (through 0Ω)

External connectors
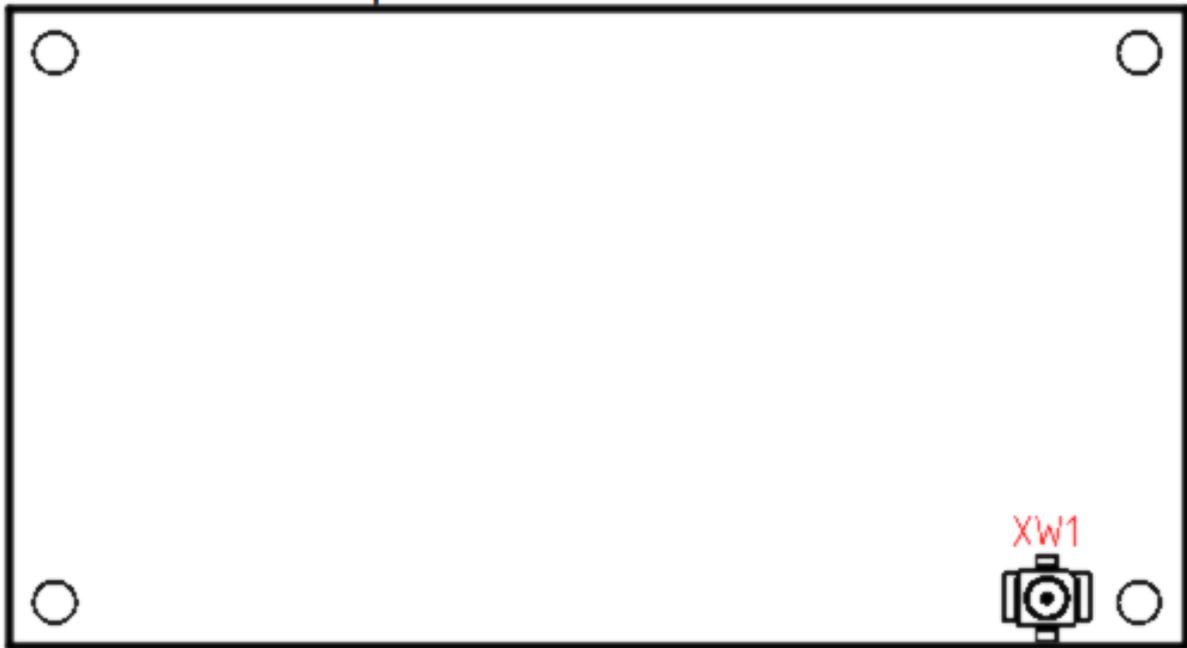
Рисунок 10: Connectors Location. Top View

Designator	P/N	Description
XW1	73412-0114	Microcoaxial connector for antenna
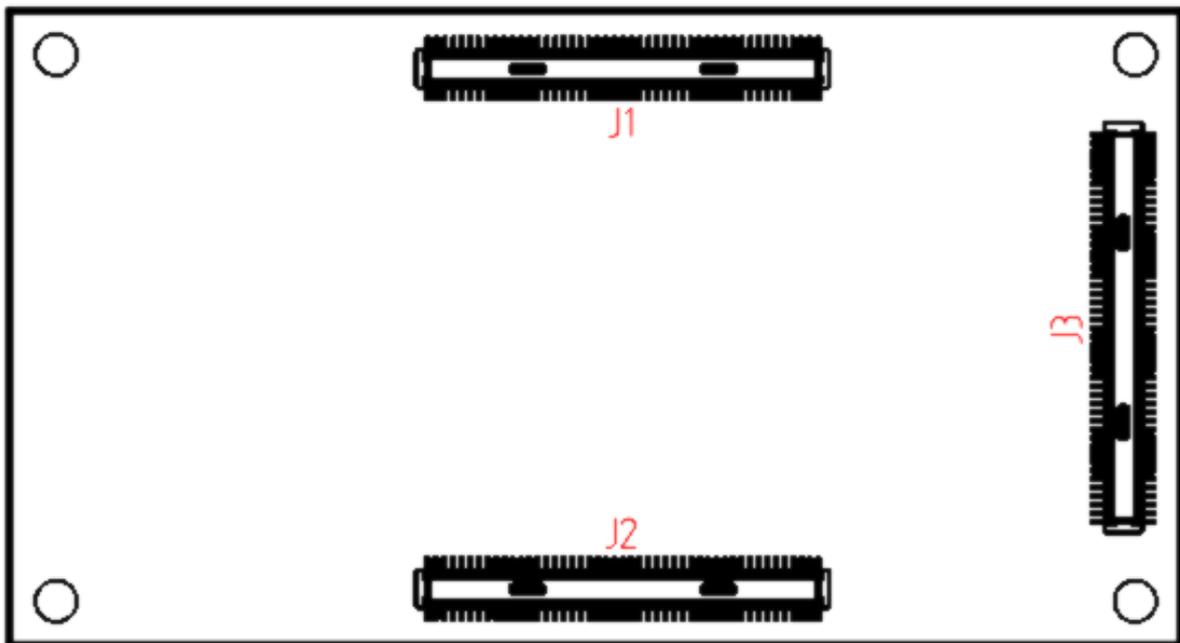
Рисунок 11: Component Location. Bottom View

Designator	P/N	Description
J1-J3	DF40C-90DP-0.4V	Composite 90-pin mezzanine connector

connectors, alternatives